

# SGM6614 18V Output, 15A, Fully Integrated Synchronous Boost Converter

# GENERAL DESCRIPTION

The SGM6614 is a 15A switch current, fully integrated synchronous Boost converter. The integrated switch FET and rectifier switch with an  $8.8 m\Omega$  low-side on-resistance and a  $12.2 m\Omega$  high-side on-resistance respectively provide high conversion efficiency for portable applications. The wide input voltage range of 2.17V to 18V offers flexibility to various input supplies such as single-cell to multi-cell Lithium batteries. The device can support up to 18V output.

The SGM6614 adopts the fixed frequency peak current mode control topology for main switch FET PWM duty cycle control. The device operates in pulse width modulation (PWM) mode at medium and heavy loads, where two power FETs are alternately turned on in one switching cycle. It automatically switches to pulse frequency modulation (PFM) mode at light loads. PWM mode adopts 500kHz switching frequency.

The SGM6614 offers various protection features to improve device robustness, such as over-voltage protection, over-current protection and thermal shutdown.

The SGM6614 is available in a Green TQFN-3×2.5-11L package.

## **FEATURES**

- 2.17V to 18V Input Voltage Range
- 4.5V to 18V Output Voltage Range
- 2.4V Minimum Input Voltage for Startup
- 15A (TYP) Peak Switch Current Limit
- 8.8mΩ Low-side and 12.2mΩ High-side MOSFETs
- Fixed 500kHz Switching Frequency
- High Efficiency
  - Up to 94.42% Efficiency at V<sub>IN</sub> = 3.6V, V<sub>OUT</sub> = 13V, and I<sub>OUT</sub> = 2A
  - Up to 97.07% Efficiency at V<sub>IN</sub> = 7.2V, V<sub>OUT</sub> = 16V, and I<sub>OUT</sub> = 2.5A
- 85µA (TYP) Quiescent Current into VOUT Pin
- Less than 1.5µA Shutdown Current
- Auto PFM at Light Loads
- 19V Output Over-Voltage Protection
- Cycle-by-Cycle Over-Current Protection
- Thermal Shutdown
- Available in a Green TQFN-3×2.5-11L Package

## **APPLICATIONS**

Smart Speaker Portable POS Power Bank

# TYPICAL APPLICATION

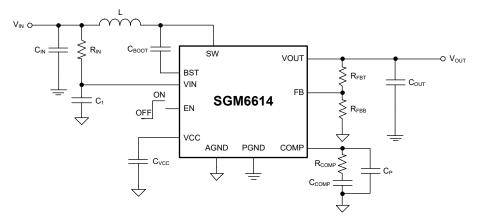


Figure 1. Typical Application

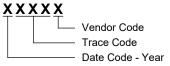


# PACKAGE/ORDERING INFORMATION

| MODEL   | PACKAGE<br>DESCRIPTION | SPECIFIED<br>TEMPERATURE<br>RANGE | ORDERING<br>NUMBER | PACKAGE<br>MARKING | PACKING<br>OPTION   |  |
|---------|------------------------|-----------------------------------|--------------------|--------------------|---------------------|--|
| SGM6614 | TQFN-3×2.5-11L         | -40°C to +125°C                   | SGM6614XTSL11G/TR  | SGMMEV<br>XXXXX    | Tape and Reel, 5000 |  |

### MARKING INFORMATION

NOTE: XXXXX = Date Code, Trace Code and Vendor Code.



Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

#### ABSOLUTE MAXIMUM RATINGS

| BST Voltage                       | 0.3V to V <sub>SW</sub> + 5.5V |
|-----------------------------------|--------------------------------|
| VIN, EN, VOUT, SW Voltages        | 0.3V to 20V                    |
| Other Pin Voltages                | 0.3V to 6V                     |
| Package Thermal Resistance        |                                |
| TQFN-3×2.5-11L, θ <sub>JA</sub>   | 63°C/W                         |
| Junction Temperature              | +150°C                         |
| Storage Temperature Range         | 65°C to +150°C                 |
| Lead Temperature (Soldering, 10s) | +260°C                         |
| ESD Susceptibility                |                                |
| HBM                               | 4000V                          |
| CDM                               | 1000V                          |

#### RECOMMENDED OPERATING CONDITIONS

| Input Voltage Range, V <sub>IN</sub>    | 2.17V to 18V     |
|---|------------------|
| Output Voltage Range, V <sub>OUT</sub>  | 4.5V to 18V      |
| Effective Inductance Range, L           | 0.8µH to 5.6µH   |
| Effective Input Capacitance Range, CIN  | 10µF (TYP)       |
| Effective Output Capacitance Range, Cou | л 10µF to 1000µF |
| Operating Junction Temperature Range    | 40°C to +125°C   |

#### **OVERSTRESS CAUTION**

Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.

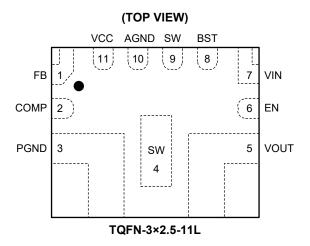
## **ESD SENSITIVITY CAUTION**

This integrated circuit can be damaged if ESD protections are not considered carefully. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because even small parametric changes could cause the device not to meet the published specifications.

#### **DISCLAIMER**

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.

# **PIN CONFIGURATION**

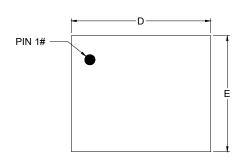


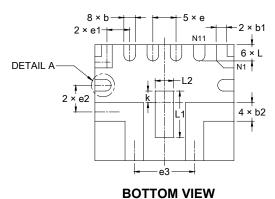
# **PIN DESCRIPTION**

| PIN  | NAME | I/O | FUNCTION  |
|------|------|-----|---|
| 1    | FB   | I   | Inverting Input of the Error Amplifier. Connect it to the midpoint of a resistor divider to set the Boost output voltage. |
| 2    | COMP | 0   | Internal Error Amplifier Output. Connect the loop compensation components between the COMP and AGND pins.                 |
| 3    | PGND | Р   | Power Ground Pin. Source connection of the internal N-channel low-side MOSFET.  |
| 4, 9 | SW   | Р   | Switching Node. Drain connection of the internal N-channel low-side MOSFET.   |
| 5    | VOUT | Р   | The Boost Output Pin.   |
| 6    | EN   | 1   | Enable Pin. Logic high turns the converter on. Logic low turns the converter off.   |
| 7    | VIN  | 1   | Input Power Supply Pin.   |
| 8    | BST  | 0   | N-Channel Rectify Switch Power Supply Pin. Connect a 0.1µF ceramic capacitor between the BST and SW pins.                 |
| 10   | AGND | -   | Signal Ground Pin.  |
| 11   | VCC  | 0   | Internal Regulator Output Pin. Connect a ceramic capacitor greater than 1.0µF between the VCC and the ground.             |

NOTE: I = input, O = output, P = power supply.

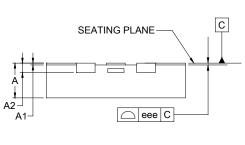
# PACKAGE OUTLINE DIMENSIONS TQFN-3×2.5-11L





**TOP VIEW** 

VIEW



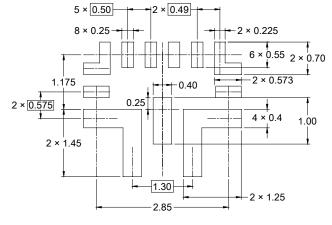
## **SIDE VIEW**

ALTERNATE A-1 ALTERNATE A-2

DETAIL A

ALTERNATE TERMINAL

CONSTRUCTION



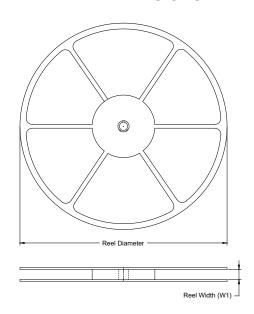
# **RECOMMENDED LAND PATTERN** (Unit: mm)

| Symbol | Dii       | Dimensions In Millimeters |       |  |  |  |  |
|--------|-----------|---------------------------|-------|--|--|--|--|
| Symbol | MIN       | NOM                       | MAX   |  |  |  |  |
| Α      | 0.700     | -                         | 0.800 |  |  |  |  |
| A1     | 0.000     | -                         | 0.050 |  |  |  |  |
| A2     | 0.203 REF |                           |       |  |  |  |  |
| b      | 0.200     | -                         | 0.300 |  |  |  |  |
| b1     | 0.175     | -                         | 0.275 |  |  |  |  |
| b2     | 0.350     | -                         | 0.450 |  |  |  |  |
| D      | 2.900     | -                         | 3.100 |  |  |  |  |
| E      | 2.400     | -                         | 2.600 |  |  |  |  |
| е      |           | 0.500 BSC                 |       |  |  |  |  |
| e1     |           | 0.490 BSC                 |       |  |  |  |  |
| e2     |           | 0.575 BSC                 | SC    |  |  |  |  |
| e3     | 1.300 BSC |                           |       |  |  |  |  |
| k      | 0.250 REF |                           |       |  |  |  |  |
| L      | 0.250     | -                         | 0.450 |  |  |  |  |
| L1     | 0.900     | -                         | 1.100 |  |  |  |  |
| L2     | 0.300     | -                         | 0.500 |  |  |  |  |
| eee    | 0.080     |                           |       |  |  |  |  |

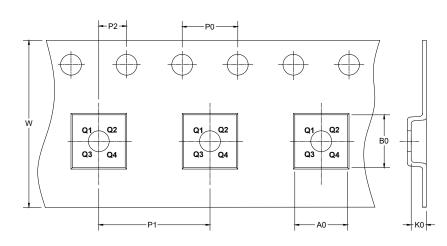
NOTE: This drawing is subject to change without notice.

# TAPE AND REEL INFORMATION

# **REEL DIMENSIONS**



# **TAPE DIMENSIONS**



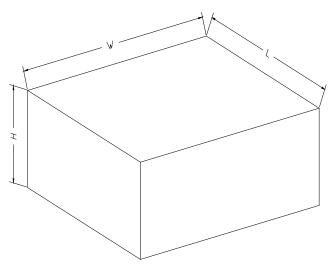
DIRECTION OF FEED

NOTE: The picture is only for reference. Please make the object as the standard.

# **KEY PARAMETER LIST OF TAPE AND REEL**

| Package Type   | Reel<br>Diameter | Reel Width<br>W1<br>(mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P0<br>(mm) | P1<br>(mm) | P2<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|----------------|------------------|--------------------------|------------|------------|------------|------------|------------|------------|-----------|------------------|
| TQFN-3×2.5-11L | 13"              | 12.4                     | 2.80       | 3.30       | 1.10       | 4.0        | 8.0        | 2.0        | 12.0      | Q2               |

# **CARTON BOX DIMENSIONS**



NOTE: The picture is only for reference. Please make the object as the standard.

# **KEY PARAMETER LIST OF CARTON BOX**

| Reel Type | Length<br>(mm) | Width Height (mm) |     | Pizza/Carton |        |
|-----------|----------------|-------------------|-----|--------------|--------|
| 13"       | 386            | 280               | 370 | 5            | 200002 |